Preparation of Papers in Double-Column Format for ADMETA^{Plus}2019

Tag mark for presenting author

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Affiliations: Times New Roman 10pt.

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Abstract

The abstract is a brief (50-80 words) synopsis of your 1 or 2 page paper. Its use is to provide a quick outline of your presentation, giving the reader an overview of the research. This is an important aspect of your paper, as it is this description that may attract the reader to continue and finish your full report.

1. Introduction

Heading, i.e. Abstract: Times New

Roman 11pt (Bold).

This sample shows basic guidelines for preparing camera-ready paper for the conference.

Authors of ADMETA^{*Plus*} 2019 are requested to submit an abstract in the PDF format, which will be compiled and distributed to conference attendees. Please read this instruction carefully and prepare your abstract. Please note that only electrical submission in the PDF format is accepted.

2. Manuscript preparation

Manuscripts should be written on vertical A4 size (210 \times 297 mm) paper. The text should be typed in double column format width 10 to 11pt font size. Times New Roman or similar fonts are recommended. Please set margins: head 25 mm, foot 25mm, left/right 20mm.

The text containing of abstract, introduction, experimental, results and discussion, conclusion, acknowledgements and references should be written on the first page. All figures, tables and photos must be arranged within the last page.

Please do not page number your paper.

3. Illustrations

Figures and tables are recommended but not required. All figures and tables must be given sequential numbers (1, 2, 3, etc.). Figure captions should be below the figures; table captions should be above the tables.

4. Manuscript submission

Send your abstract to the Program Committee of ADMETA^{*Plus*} 2019 via e-mail in the PDF format.

Acknowledgement

We would like to express sincere thanks to all the contributors of the conference for their cooperation in the conference program.

References

[1] T. Admeta and J. Amc, Jpn. J. Appl. Phys. 43 (1998) 123.

- [2] J. Ssdm, Extended Abstrack Conference on Solid State Devices and Materials (1999) 456.
- [3] A. Iitc and Y. Iedm, *Advanced Metallization and Interconnect Systems for ULSI Applications* (2000) 789.

| Table I. Desi | rable Fonts |
|---------------|-------------|
|---------------|-------------|

| Font size | Bold/Italic | Text |
|--------------|-------------|---|
| 10pt | | Affiliation(s), Main text |
| 10pt | Bold | Headings (e.g., 1. Introduction) |
| 12pt | | Author name(s) |
| 14pt | Bold | Title |
| 10pt | Italic | Subheadings (e.g., Page Format) |
| 9pt | | References, Acknowledgements, Tables, Table captions, Figure captions |
| 8pt | | Footnotes, Sub-and superscripts |

Figure should appear as part of the text, instead where mentioned.

Fig. 1 Figure Caption.